

RX Family

LPT Module Using Firmware Integration Technology

Abstract

This application note describes the LPT module using firmware integration technology (FIT). This module uses the low-power timer (LPT) to produce a signal to exit software standby mode. The MCU can periodically exit software standby mode using this module with software standby mode and ELC.

Hereinafter this module is referred to as the “LPT FIT module”.

Target Devices

The following is a list of devices that are currently supported by this API:

- RX113 Group
- RX130 Group
- RX231, RX230 Groups
- RX23W Group

When using this application note with other Renesas MCUs, careful evaluation is recommended after making modifications to comply with the alternate MCU.

Target Compilers

- Renesas Electronics C/C++ Compiler Package for RX Family
- GCC for Renesas RX
- IAR C/C++ Compiler for Renesas RX

For details of the confirmed operation contents of each compiler, refer to “6.1 Operation Confirmation Environment”.

Related Documents

For additional information associated with this document, refer to the following application notes.

- Board Support Package Module Using Firmware Integration Technology (R01AN1685)

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1. Specifications

The LPT FIT module supports the LPT which is the RX Family peripheral function and produces a signal to exit software standby mode.

The MCU can periodically exit software standby mode using this module with software standby mode and the event link controller (ELC).

1.1 LPT FIT Module

The LPT FIT module can be used by being implemented in a project as an API. See section 2.11 Adding the FIT Module to Your Project for details on methods to implement this FIT module into a project.

1.2 Overview of the LPT FIT Module

Settings for operating the LPT are configured by calling the `R_LPT_Open` function in this module. Also the LPT cycle is specified by calling `R_LPT_Open` function. Then register values necessary to use the LPT are set.

If the LPT cycle needs to be changed after the LPT has started operating, first call the `R_LPT_Close` function, set the argument with information to be changed, and then call the `R_LPT_Open` function.

When starting LPT count, call the `R_LPT_Control` function using the `LPT_CMD_START` command.

When stopping LPT count, call the `R_LPT_Control` function using the `LPT_CMD_STOP` command.

When resetting LPT count, call the `R_LPT_Control` function using the `LPT_CMD_COUNT_RESET` command.

Transition from software standby mode to the ELC operation enable state is triggered by the compare match 0 occurrence.

When using this module, the LPT must not be controlled by any other modules.

1.3 API Overview

Table 1.1 lists the API functions included in the module.

Table 1.1 API Functions

Function	Description
<code>R_LPT_Open</code>	Initializes the LPT for using this module.
<code>R_LPT_Close</code>	Releases the LPT module.
<code>R_LPT_Control</code>	Controls start/stop/reset of LPT count.
<code>R_LPT_GetVersion</code>	Returns the version of this module.

1.4 Processing Example

Figure 1.1 shows an example of processing. The following is an example of the LPT FIT module.

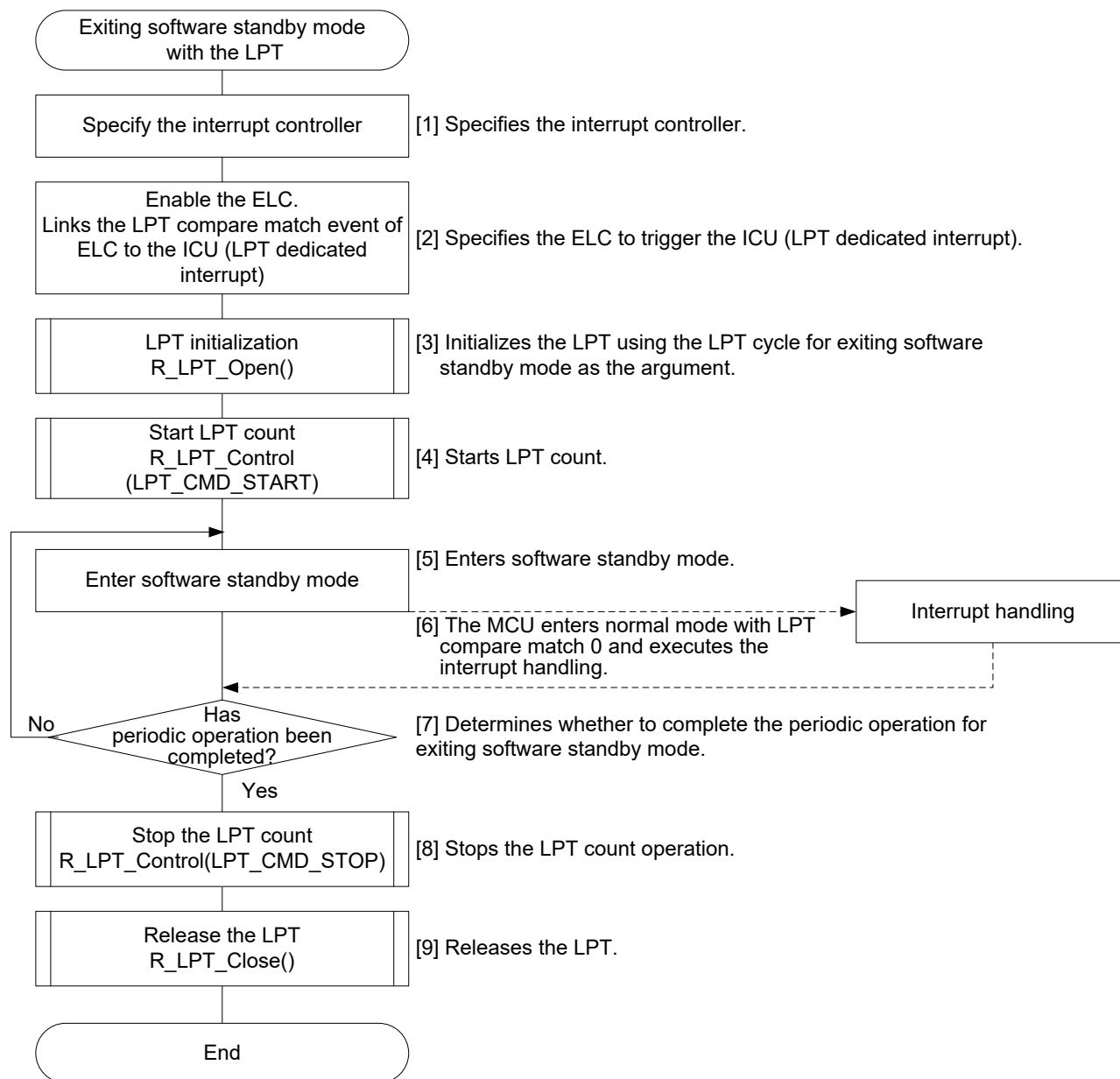


Figure 1.1 Processing Example of the LPT FIT Module

1.5 State Transition

Figure 1.2 shows the state transition diagram for this module.

The following is the state transition of the LPT FIT module as an example.

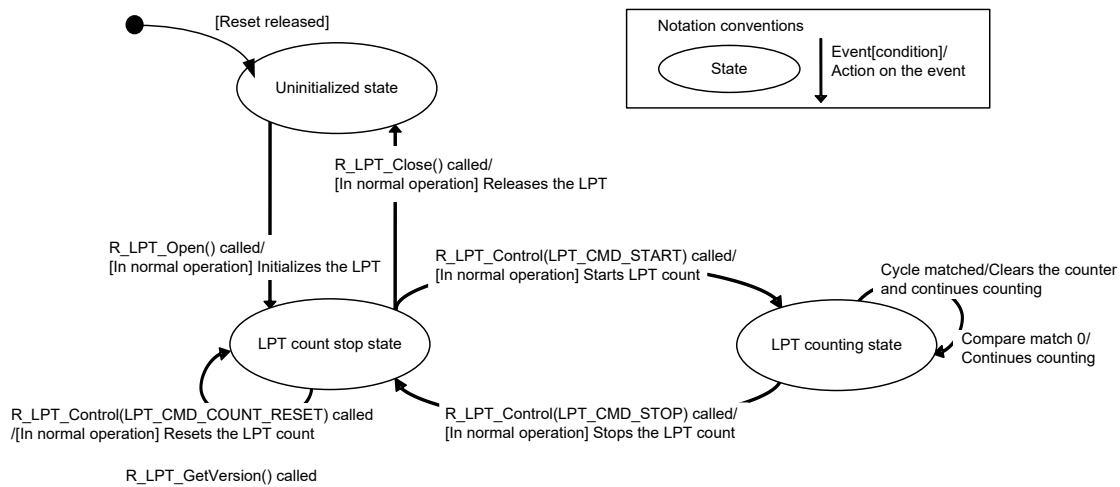


Figure 1.2 LPT FIT Module State Transition Diagram

2. API Information

This FIT module has been confirmed to operate under the following conditions.

2.1 Hardware Requirements

This driver requires your MCU support the following features:

- Low-power timer (LPT)
- Event link controller (ELC)
- Low power consumption (LPC)

2.2 Software Requirements

This driver is dependent upon the following packages:

- Renesas Board Support Package (r_bsp)

2.3 Supported Toolchains

This driver has been confirmed to work with the toolchain listed in 6.1, Operation Confirmation Environment.

2.4 Interrupt Vector

This FIT module does not use interrupt vectors.

2.5 Header Files

All API calls and their supporting interface definitions are located in r_lpt_rx_if.h.

2.6 Integer Types

This project uses ANSI C99. These types are defined in stdint.h.

2.7 Configuration Overview

The configuration options in this module are specified in `r_lpt_rx_config.h`. The option names and setting values are listed in the table below.

Configuration options in <i>r_lpt_rx_config.h</i>	
<pre>#define LPT_CFG_PARAM_CHECKING (1)</pre>	<p>Selects whether to include parameter checking in the code. The parameter checking is processing to check parameters and is located in the beginning of each function.</p> <ul style="list-style-type: none"> - When this is set to 0, code for parameter checking is not generated. - When this is set to 1, code for parameter checking is generated and executed. <p>And, definition of "LPT_CFG_PARAM_CHECKING" is invalid when definition of "BSP_CFG_PARAM_CHECKING_ENABLE" is set 0. Then Parameter checking code is invalid.</p>
<pre>#define LPT_CFG_LPT_CLOCK_SOURCE (0)</pre> <p>A default value is "BSP_CFG_PARAM_CHECKING_ENABLE" which is defined in <code>r_bsp_config.h</code> file.</p>	<p>Selects the clock source for the low-power timer.</p> <ul style="list-style-type: none"> - When this is set to 0, the sub-clock oscillator is selected. - When this is set to 1, the IWDG-dedicated on-chip oscillator is selected.

2.8 Code Size

The sizes of ROM, RAM and maximum stack usage associated with this module are listed below.

The ROM (code and constants) and RAM (global data) sizes are determined by the build-time configuration options described in 2.7, Configuration Overview.

The values in the table below are confirmed under the following conditions.

Module Revision: r_lpt_rx rev2.00

Compiler Version: Renesas Electronics C/C++ Compiler Package for RX Family V3.02.00

(The option of “-lang = c99” is added to the default settings of the integrated development environment.)

GCC for Renesas RX 4.8.4.201904

(The option of “-std=gnu99” is added to the default settings of the integrated development environment.)

IAR C/C++ Compiler for Renesas RX version 4.14.1

(The default settings of the integrated development environment.)

Configuration Options: Default settings

ROM, RAM and Stack Code Sizes							
Device	Category	Memory Used					
		Renesas Compiler		GCC		IAR Compiler	
		With Parameter Checking	Without Parameter Checking	With Parameter Checking	Without Parameter Checking	With Parameter Checking	Without Parameter Checking
RX113	ROM	589 bytes	580 bytes	1,212 bytes	1,196 bytes	1,086 bytes	1,078 bytes
RX130	RAM	0 bytes		0 bytes		0 bytes	
RX230							
RX231	STACK	96 bytes		-		140 bytes	
RX23W							

2.9 Parameters

This section describes the parameter the enumeration used by the API functions in this module. The enumeration is located in `r_lpt_rx_if.h` as are the prototype declarations of API functions.

```
typedef enum e_lpt_cmd
{
    LPT_CMD_START,          /* Start LPT count */
    LPT_CMD_STOP            /* Stop LPT count */
    LPT_CMD_COUNT_RESET    /* Reset LPT count */
} lpt_cmd_t;
```

2.10 Return Values

This section describes return values of API functions. This enumeration is located in `r_lpt_rx_if.h` as are the prototype declarations of API functions.

```
typedef enum /* Status codes for LPT APIs */
{
    LPT_SUCCESS:           /* Processing completed successfully. */
    LPT_ERR_LOCK_FUNC:     /* Operating. LPT has been used. */
    LPT_ERR_INVALID_ARG:   /* Argument has an invalid value. */
    LPT_ERR_CONDITION_NOT_MET: /* Condition not met. */
} lpt_err_t;
```

2.11 Adding the FIT Module to Your Project

This module must be added to each project in which it is used. Renesas recommends the method using the Smart Configurator described in (1) or (3) or (5) below. However, the Smart Configurator only supports some RX devices. Please use the methods of (2) or (4) for RX devices that are not supported by the Smart Configurator.

- (1) Adding the FIT module to your project using the Smart Configurator in e² studio
By using the Smart Configurator in e² studio, the FIT module is automatically added to your project. Refer to “RX Smart Configurator User’s Guide: e² studio (R20AN0451)” for details.
- (2) Adding the FIT module to your project using the FIT Configurator in e² studio
By using the FIT Configurator in e² studio, the FIT module is automatically added to your project. Refer to “RX Family Adding Firmware Integration Technology Modules to Projects (R01AN1723)” for details.
- (3) Adding the FIT module to your project using the Smart Configurator in CS+
By using the Smart Configurator Standalone version in CS+, the FIT module is automatically added to your project. Refer to “RX Smart Configurator User’s Guide: CS+ (R20AN0470)” for details.
- (4) Adding the FIT module to your project in CS+
In CS+, please manually add the FIT module to your project. Refer to “RX Family Adding Firmware Integration Technology Modules to CS+ Projects (R01AN1826)” for details.
- (5) Adding the FIT module to your project using the Smart Configurator in IAREW
By using the Smart Configurator Standalone version, the FIT module is automatically added to your project. Refer to “RX Smart Configurator User’s Guide: IAREW (R20AN0535)” for details.

2.12 “for”, “while” and “do while” statements

In this module, “for”, “while” and “do while” statements (loop processing) are used in processing to wait for register to be reflected and so on. For these loop processing, comments with “WAIT_LOOP” as a keyword are described. Therefore, if user incorporates fail-safe processing into loop processing, user can search the corresponding processing with “WAIT_LOOP”.

The following shows example of description.

```
while statement example :
/* WAIT_LOOP */
while(0 == SYSTEM.OSCOVFSR.BIT.PLOVF)
{
    /* The delay period needed is to make sure that the PLL has stabilized. */
}

for statement example :
/* Initialize reference counters to 0. */
/* WAIT_LOOP */
for (i = 0; i < BSP_REG_PROTECT_TOTAL_ITEMS; i++)
{
    g_protect_counters[i] = 0;
}

do while statement example :
/* Reset completion waiting */
do
{
    reg = phy_read(ether_channel, PHY_REG_CONTROL);
    count++;
} while ((reg & PHY_CONTROL_RESET) && (count < ETHER_CFG_PHY_DELAY_RESET)); /* WAIT_LOOP */
```

3. API Functions

R_LPT_Open ()

The function initializes the LPT FIT module. This function must be called before calling any other API functions.

Format

```
lpt_err_t R_LPT_Open (  
    uint32_t const period  
)
```

Parameters

uint32_t const period
LPT cycle (unit: μ s)

Return Values

<i>LPT_SUCCESS:</i>	<i>/* Processing completed successfully. */</i>
<i>LPT_ERR_LOCK_FUNC:</i>	<i>/* Operating. LPT has been used. */</i>
<i>LPT_ERR_INVALID_ARG:</i>	<i>/* Argument has an invalid value. */</i>

Properties

Prototyped in r_lpt_rx_if.h.

Description

The initialization is performed to start LPT operation and then the LPT cycle specified with the argument is set.

Operations included in the initialization are as follows:

- Enables exiting software standby mode using the LPT.
- Sets the LPT clock source and the division ratio.
- Enables compare match 0.
- Sets the LPT cycle.
- Sets the value of LPT compare match 0.
- Provides the LPT clock.
- Resets the LPT.

Example

```
void main(void)
{
    lpt_err_t err;
    uint32_t period;

    period = 100000;
    err = R_LPT_Open(period);
    if (LPT_SUCCESS != err)
    {
        while(1) { };
    }
}
```

Special Notes

Call this function while the LPT clock source oscillation is stabilized.

When the sub-clock oscillator is selected as the LPT clock source, the LPT cycle must be specified from 153 to 64000488.

When the IWDT-dedicated on-chip oscillator is selected as the LPT clock source, the LPT cycle must be specified from 334 to 139811199.

When the IWDT-dedicated on-chip oscillator is selected as the LPT clock source, set the OFS0.IWDTSLCSTP bit to 0 (counting stop is disabled) in IWDT auto-start mode, and set the IWDTCSLTPR.SLCSTP bit to 0 (counting stop is disabled) in other modes.

MCU executes the program after MCU waits for the stability time for Main Clock Oscillator Wait Control Register (SMOSCWTCR) when MCU is resumed from software standby mode.

R_LPT_Close ()

This function performs processing to stop the LPT.

Format

```
lpt_err_t R_LPT_Close (  
    void  
)
```

Parameters

None

Return Values

LPT_SUCCESS: / Processing completed successfully. */*

Properties

Prototyped in r_lpt_rx_if.h.

Description

The following operations are performed to stop the LPT.

- Stops the LPT.
- Resets the LPT if the LPT clock is provided.
- Stops the LPT clock.
- Resets the value of LPT compare match 0.
- Resets the LPT cycle.
- Resets low-power timer control register 1.
- Disables exiting software standby mode using the LPT.

Example

```
void main(void)
{
    lpt_err_t err;
    uint32_t period;

    period = 100000;
    err = R_LPT_Open(period);
    if (LPT_SUCCESS != err)
    {
        while(1) { };
    }

    err = R_LPT_Close();
    if (LPT_SUCCESS != err)
    {
        while(1) { };
    }
}
```

Special Notes

Configure the LPT settings in the R_LPT_Open function first, wait one or more cycles of the LPT clock source, and then call this function.

R_LPT_Control ()

This function performs processing to start, stop, or reset LPT count.

Format

```
lpt_err_t R_LPT_Control (  
    lpt_cmd_t const cmd      /* Command */  
)
```

Parameters

lpt_cmd_t const *cmd*
Command to be executed (see 2.9, Parameters).

Return Values

LPT_SUCCESS: */* Processing completed successfully. */*
LPT_ERR_INVALID_ARG: */* Argument has an invalid value. */*
LPT_ERR_CONDITION_NOT_MET */* Condition not met. */*

Properties

Prototyped in r_lpt_rx_if.h.

Description

This API function controls start/stop of LPT count.

The counter reset command (LPT_CMD_COUNT_RESET) must be executed while LPT count stops. If LPT_CMD_COUNT_RESET is executed during counting, LPT_ERR_CONDITION_NOT_MET is returned.

Example

```
void main(void)  
{  
    lpt_err_t err;  
    uint32_t period;  
  
    period = 100000;  
    err = R_LPT_Open(period);  
    if (LPT_SUCCESS != err)  
    {  
        while(1) { };  
    }  
  
    err = R_LPT_Control(LPT_CMD_START);  
    if (LPT_SUCCESS != err)  
    {  
        while(1) { };  
    }  
}
```

Special Notes

Call this function after the LPT have been configured in the R_LPT_Open function.

R_LPT_GetVersion ()

This function returns the module version.

Format

```
uint32_t R_LPT_GetVersion (  
    void  
)
```

Parameters

None

Return Values

Version number

Properties

Prototyped in r_lpt_rx_if.h.

Description

Returns the module version number. The version number is encoded where the top 2 bytes are the major version number and the bottom 2 bytes are the minor version number.

Example

```
void main(void)  
{  
    uint32_t version;  
  
    version = R_LPT_GetVersion();  
    while(1) { };  
}
```

Special Notes

None

4. Sample Code

This section describes the sample code for periodically exiting software standby mode using the LPT.

Operations are performed in the following order.

- (1) Calls the R_LPC_LowPowerModeConfigure function to enable software standby mode.
- (2) Cancels the module stop state for the ELC.
- (3) Disables maskable interrupts.
- (4) Disables DTC activation by the ELSR19I interrupt to set the communication target of the ELSR19I interrupt to the CPU.
- (5) Disables the ELSR19I interrupt.
- (6) Specifies the interrupt priority level of the ELSR19I interrupt higher than the processor interrupt priority level (IPL).
- (7) Enables the ELSR19I interrupt.
- (8) Enables the ELC function.
- (9) Links the LPT compare match event of ELC to ICU (LPT dedicated interrupt).
- (10) Calls the R_LPT_Open function to enable for the LPT FIT module to use the LPT.
- (11) Calls the R_LPT_Control function to start LPT count.
- (12) Calls the R_LPC_LowPowerModeActivate function to enter software standby mode.
- (13) With LPT compare match 0 occurrence, enters normal operation mode and then calls ELSR19I interrupt exception handling.
- (14) Returns step 12 after executing user processing after exiting software standby mode.

- This sample code supports on RX113.
- This program uses the LPC FIT module. About the LPC FIT module, please refer to Renesas Electronics Website.

```
#include "platform.h"
#include "r_lpc_rx100_if.h"
#include "r_lpt_rx_if.h"
```

```
void main(void);
```

```
void main(void)
```

```
{
```

```
    lpt_err_t lpt_err;
    uint32_t period;
    lpc_err_t lpc_err;
```

When the IWDTCSTPR.BIT.SLCSTP is selected as the LPT clock source, the setting not to stop the clock during software standby is required.

```
/* ---- Disable to stop counting in sleep mode. ---- */
IWDTCSTPR.BIT.SLCSTP = 0;
```

```
/* ---- Software standby mode setting ---- */
lpc_err = R_LPC_LowPowerModeConfigure(LPC_LP_SW_STANDBY);
if (LPC_SUCCESS != lpc_err)
{
    while(1) { };
}
```

```
/* Cancel the module stop state for the ELC. */
R_BSP_RegisterProtectDisable(BSP_REG_PROTECT_LPC_CGC_SWR);
MSTP(ELC) = 0;
R_BSP_RegisterProtectEnable(BSP_REG_PROTECT_LPC_CGC_SWR);
```

```
/* ---- Disable maskable interrupts. ---- */
R_BSP_InterruptsDisable();
```

Transition from the ELC operation enable state to normal operation mode is made using the ELSR19I interrupt.

```
/* ---- ELSR19I interrupt settings ---- */
ICU.DTCER[80].BIT.DTCE = 0;
ICU.IER[0x0A].BIT.IEN0 = 0;
ICU.IPR[80].BIT.IPR = 15;
ICU.IER[0x0A].BIT.IEN0 = 1;
while ( 1 != ICU.IER[0x0A].BIT.IEN0 )
{
    /* Check if the written value is correctly reflected. */
}
```

```
/* ---- ELC settings ---- */
ELC.ELCR.BIT.ELCON = 1; /* ELC function is enabled. */
ELC.ELSR[19].BIT.ELS = 0x5D; /* Links the LPT compare match event of ELC (5Dh)
                             to ICU (LPT dedicated interrupt). */
```

```
/* ---- LPT initialization ---- */
period = 100000; /* LPT cycle = 100000[μs] */
lpt_err = R_LPT_Open(period);
if (LPT_SUCCESS != lpt_err)
{
    while(1) { };
}
```

The ELSR19I interrupt is triggered by completion of the transition from software standby mode to the ELC operation enable state.

```
/* ---- Start LPT count. ---- */
lpt_err = R_LPT_Control(LPT_CMD_START);
if (LPT_SUCCESS != lpt_err)
{
    while(1) { };
}

while(1)
{
    /* ---- Enter software standby mode. ---- */
    lpc_err = R_LPC_LowPowerModeActivate(NULL);
    if (LPC_SUCCESS != lpc_err)
    {
        while(1) { };
    }
    /* ---- Write user processing after exiting software standby mode. ---- */
}
```

Figure 4.1 Example of Processing for Periodically Exiting Software Standby Mode Using the LPT

5. Demo Projects

Demo projects are complete stand-alone programs. They include function main() that utilizes the module and its dependent modules (e.g. r_bsp). This FIT module has the following demo projects:

5.1 `lpt_demo_rskrx231`

This section describes the sample code for periodically exiting software standby mode using the LPT.

The demo will be executed through these steps:

- (1) Configured LPC module for Software standby mode
- (2) Configure IWDG clock not to stop counting in Software standby mode
- (3) Cancel module stop-state for ELC
- (4) Disable DTC activation so the interrupt request will send directly to CPU
- (5) Configure ELC module Low-power timer count down match event
- (6) Start ELC and LPT operation
- (7) Main loop: Enter software standby mode in 3 seconds and then return back to normal operation mode

Notes:

- This program uses the LPC FIT module. About the LPC FIT module, please refer to Renesas Electronics Website
- When debugging with e² studio, to know if the program is in Software Standby mode or Normal mode, user can observe the program running status on the bottom left corner of e² studio window:
 - **Standby**: the program is in Software Standby mode.
 - **Running**: the program is in Normal mode.
- To enable the LPT clock source, the LPT clock source (BSP_CFG_LPT_CLOCK_SOURCE) of BSP is changed from the initial value to the sub clock.

How to confirm:

- Program will print out a message on the console notify about entering software standby mode.
- Program will enter software standby mode in 3 seconds, CPU and all peripheral functions without setting of module stop state will stop in this mode.
- After 3 seconds, program will return back to normal mode, print out a notify message on the console and blink LED 0 in 1 second.

5.2 `lpt_demo_rskrx113`

The `lpt_demo_rskrx113` program is identical to `lpt_demo_rskrx231`.

Note: To enable the LPT clock source, the LPT clock source (BSP_CFG_LPT_CLOCK_SOURCE) of BSP is changed from the initial value to the IWDG dedicated on-chip oscillator.

5.3 Adding a Demo to a Workspace

Demo projects are found in the FIT Demos subdirectory of the distribution file for this application note. To add a demo project to a workspace, select *File >> Import >> General >> Existing Projects into Workspace*, then click "Next". From the Import Projects dialog, choose the "Select archive file" radio button. "Browse" to the FIT Demos subdirectory, select the desired demo zip file, then click "Finish".

5.4 Downloading Demo Projects

Demo projects are not included in the RX Driver Package. When using the demo project, the FIT module needs to be downloaded. To download the FIT module, right click on the required application note and select "Sample Code (download)" from the context menu in the *Smart Browser* >> *Application Notes* tab.

6. Appendices

6.1 Operation Confirmation Environment

This section describes operation confirmation environment for the LPT FIT module.

Table 6.1 Operation Confirmation Environment (Rev. 2.01)

Item	Contents
Integrated development environment	Renesas Electronics e ² studio 2020-10 (20.10.0)
C compiler	Renesas Electronics C/C++ Compiler Package for RX Family V3.02.00 Compiler option: The following option is added to the default settings of the integrated development environment. -lang = c99
Endian	Big endian/little endian
Revision of the module	Rev.2.01
Board used	Renesas Starter Kit for RX113 (product No: R0K505113SxxxBE) Renesas Starter Kit for RX231 (product No: R0K505231SxxxBE)

Table 6.2 Operation Confirmation Environment (Rev. 2.00)

Item	Contents
Integrated development environment	Renesas Electronics e ² studio Version 7.8.0 IAR Embedded Workbench for Renesas 4.14.01
C compiler	Renesas Electronics C/C++ Compiler Package for RX Family V3.02.00 Compiler option: The following option is added to the default settings of the integrated development environment. -lang = c99
	GCC for Renesas RX 8.03.00.201904 Compiler option: The following option is added to the default settings of the integrated development environment. -std=gnu99
	IAR C/C++ Compiler for Renesas RX version 4.14.01 Compiler option: The default settings of the integrated development environment.
Endian	Big endian/little endian
Revision of the module	Rev.2.00
Board used	Renesas Solution Starter Kit for RX23W (product No.: RTK5523Wxxxxxxxxxx) Renesas Starter Kit for RX231 (product No.: R0K505231xxxxxx)

Table 6.3 Operation Confirmation Environment (Rev. 1.23)

Item	Contents
Integrated development environment	Renesas Electronics e ² studio Version 7.3.0
C compiler	Renesas Electronics C/C++ Compiler Package for RX Family V3.01.00 Compiler option: The following option is added to the default settings of the integrated development environment. -lang = c99
Endian	Big endian/little endian
Revision of the module	Rev.1.23

Table 6.4 Operation Confirmation Environment (Rev. 1.22)

Item	Contents
Integrated development environment	Renesas Electronics e ² studio Version 7.3.0
C compiler	Renesas Electronics C/C++ Compiler Package for RX Family V3.01.00 Compiler option: The following option is added to the default settings of the integrated development environment. -lang = c99
Endian	Big endian/little endian
Revision of the module	Rev.1.22
Board used	Renesas Starter Kit+ for RX113 (product No: R0K505113SxxxBE)

Table 6.5 Operation Confirmation Environment (Rev. 1.21)

Item	Contents
Integrated development environment	Renesas Electronics e ² studio Version 6.0.0
C compiler	Renesas Electronics C/C++ Compiler Package for RX Family V2.07.00 Compiler option: The following option is added to the default settings of the integrated development environment. -lang = c99
Endian	Big endian/little endian
Revision of the module	Rev.1.21
Board used	Renesas Starter Kit+ for RX130-512KB (product No: RTK5051308SxxxxxBE)

Table 6.6 Operation Confirmation Environment (Rev. 1.20)

Item	Contents
Integrated development environment	Renesas Electronics e ² studio Version 6.0.0.001
C compiler	Renesas Electronics C/C++ Compiler Package for RX Family V2.07.00 Compiler option: The following option is added to the default settings of the integrated development environment. -lang = c99
Endian	Big endian/little endian
Revision of the module	Rev.1.20
Board used	Renesas Starter Kit+ for RX130-512KB (product No: RTK5051308SxxxxxBE)

Table 6.7 Operation Confirmation Environment (Rev. 1.11)

Item	Contents
Integrated development environment	Renesas Electronics e ² studio Version 5.0.1.005
C compiler	Renesas Electronics C/C++ Compiler Package for RX Family V2.05.00 Compiler option: The following option is added to the default settings of the integrated development environment. -lang = c99
Endian	Big endian/little endian
Revision of the module	Rev.1.11
Board used	Renesas Starter Kit+ for RX113 (product No: R0K505113SxxxBE) Renesas Starter Kit+ for RX231 (product No: R0K505231SxxxBE) Renesas Starter Kit+ for RX130 (product No: RTK5005130SxxxxxBE)

Table 6.8 Operation Confirmation Environment (Rev. 1.10)

Item	Contents
Integrated development environment	Renesas Electronics e ² studio Version 5.0.0.043
C compiler	Renesas Electronics C/C++ Compiler Package for RX Family V2.04.01 Compiler option: The following option is added to the default settings of the integrated development environment. -lang = c99
Endian	Big endian/little endian
Revision of the module	Rev.1.10
Board used	Renesas Starter Kit+ for RX113 (product No: R0K505113SxxxBE) Renesas Starter Kit+ for RX231 (product No: R0K505231SxxxBE) Renesas Starter Kit+ for RX130 (product No: RTK5005130SxxxxxBE)

Table 6.9 Operation Confirmation Environment (Rev. 1.00)

Item	Contents
Integrated development environment	Renesas Electronics e ² studio Version 4.2.0.012
C compiler	Renesas Electronics C/C++ Compiler Package for RX Family V2.04.01 Compiler option: The following option is added to the default settings of the integrated development environment. -lang = c99
Endian	Big endian/little endian
Revision of the module	Rev.1.00
Board used	Renesas Starter Kit+ for RX113 (product No: R0K505113SxxxBE)

6.2 Troubleshooting

(1) Q: I have added the FIT module to the project and built it. Then I got the error: Could not open source file "platform.h".

A: The FIT module may not be added to the project properly. Check if the method for adding FIT modules is correct with the following documents:

- Using CS+:

Application note "Adding Firmware Integration Technology Modules to CS+ Projects (R01AN1826)"

- Using e² studio:

Application note "Adding Firmware Integration Technology Modules to Projects (R01AN1723)"

When using a FIT module, the board support package FIT module (BSP module) must also be added to the project. Refer to the application note "Board Support Package Module Using Firmware Integration Technology (R01AN1685)".

(2) Q: I have added the FIT module to the project and built it. Then I got the error: This MCU is not supported by the current r_lpt_rx module.

A: The FIT module you added may not support the target device chosen in your project. Check the supported devices of added FIT modules.

(3) Q: I have added the FIT module to the project and built it. Then I got an error for when the configuration setting is wrong.

A: The setting in the file "r_lpt_rx_config.h" may be wrong. Check the file "r_lpt_rx_config.h". If there is a wrong setting, set the correct value for that. Refer to 2.7, Configuration Overview for details.

Revision History

Rev.	Date	Description	
		Page	Summary
1.00	Mar. 1, 2016	-	First edition issued
1.10	July. 1, 2016	all	Added supported devices for RX130, RX231 and RX230.
		All	Improved the Accuracy of the LPT periodic time when using the IWDG-dedicated on-chip oscillator to LPT clock source.
		10	Changed the periodic range for the argument of the API when LPT using the IWDG oscillator by improved influence to the Accuracy of the LPT periodic time.
		10	Added the note for the LPT periodic time on special note of section 3.1.
1.11	Oct. 1, 2016	All	Added the LPT counter reset command (LPT_CMD_COUNT_RESET) for the R_LPT_Control function.
		8, 13	Added LPT_ERR_CONDITION_NOT_MET to the Return Values.
		Program	Added the LPT counter reset command (LPT_CMD_COUNT_RESET) for the R_LPT_Control function.
		Program	Added LPT_ERR_CONDITION_NOT_MET as the return value.
1.20	Oct. 1, 2017	all	Added supported devices for RX130-512KB.
		1	Added the following document to Related Documents. “Renesas e2 studio Smart Configurator User Guide (R20AN0451)”
		3, 7	Move "Required memory size" in Chapter 1.2 to chapter 2.7.
		8	Revised 2.11 Adding the FIT Module to Your Project.
		17, 18	Added 5.1 Operation Confirmation Environment.
		19	Added 5.2 Troubleshooting.
1.21	Oct. 31, 2017	17	Added 5. Demo Projects
		18	6.1 Operation Confirmation Environment: Added table for Rev.1.21
		20	6.2 Troubleshooting: Added 2 more questions
1.22	Nov 16, 2018	–	Added document number in XML
		8	Updated “2.11 Adding the FIT Module to Your Project” Added “2.12 “for”, “while” and “do while” statements”
		18	Added table for Rev.1.22
1.23	Apr 01, 2019	–	Changes associated with functions: Added support setting function of configuration option Using GUI on Smart Configurator. [Description] Added a setting file to support configuration option setting function by GUI.
		3	Moved 1.3 API Overview.
		4	Changed 1.4 Processing Example.
		5	Changed 1.5 State Transition.
		6	Changed 2 API Information. Added 2.4 Interrupt Vector.
		7	Changed 2.8 Code Size.
		8	Changed 2.9 Parameters. Deleted Callback Function.
		9	Changed 2.12 “for”, “while” and “do while” statements.
		15	Changed R_LPT_GetVersion.

Rev.	Date	Description	
		Page	Summary
1.23	Apr 01, 2019	19	6.1 Operation Confirmation Environment: Added table for Rev.1.23.
2.00	Jun 10, 2020	-	Added support for RX23W Modified comment of API function to Doxygen style. Update the following compilers - GCC for Renesas RX - IAR C/C++ Compiler for Renesas RX.
		1	Added Target Compilers.
		1	Related Documents: Deleted the following documents Firmware Integration Technology User's Manual (R01AN1833) RX Family Adding Firmware Integration Technology Modules to Projects (R01AN1723) RX Family Adding Firmware Integration Technology Modules to CS+ Projects (R01AN1826) Renesas e ² studio Smart Configurator User Guide (R20AN0451)
		7	Changed 2.8 Code Size.
		8	Changed 2.11 Adding the FIT Module to Your Project.
		9	Deleted Target devices describing "WAIT_LOOP".
		10..15	Deleted the Reentrant for each API in 3. API Functions.
		19	Changed 5.1 lpt_demo_rskrx231. Changed 5.2 lpt_demo_rskrx113.
		21	6.1 Operation Confirmation Environment: Added table for Rev.2.00.
2.01	Nov.30.20	-	Updated the sample code project due to the upgrade of the development environment.

General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

1. Precaution against Electrostatic Discharge (ESD)

A strong electrical field, when exposed to a CMOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop the generation of static electricity as much as possible, and quickly dissipate it when it occurs. Environmental control must be adequate. When it is dry, a humidifier should be used. This is recommended to avoid using insulators that can easily build up static electricity.

Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors must be grounded. The operator must also be grounded using a wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions must be taken for printed circuit boards with mounted semiconductor devices.

2. Processing at power-on

The state of the product is undefined at the time when power is supplied. The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the time when power is supplied. In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the time when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the time when power is supplied until the power reaches the level at which resetting is specified.

3. Input of signal during power-off state

Do not input signals or an I/O pull-up power supply while the device is powered off. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Follow the guideline for input signal during power-off state as described in your product documentation.

4. Handling of unused pins

Handle unused pins in accordance with the directions given under handling of unused pins in the manual. The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of the LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible.

5. Clock signals

After applying a reset, only release the reset line after the operating clock signal becomes stable. When switching the clock signal during program execution, wait until the target clock signal is stabilized. When the clock signal is generated with an external resonator or from an external oscillator during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Additionally, when switching to a clock signal produced with an external resonator or by an external oscillator while program execution is in progress, wait until the target clock signal is stable.

6. Voltage application waveform at input pin

Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between V_{IL} (Max.) and V_{IH} (Min.) due to noise, for example, the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between V_{IL} (Max.) and V_{IH} (Min.).

7. Prohibition of access to reserved addresses

Access to reserved addresses is prohibited. The reserved addresses are provided for possible future expansion of functions. Do not access these addresses as the correct operation of the LSI is not guaranteed.

8. Differences between products

Before changing from one product to another, for example to a product with a different part number, confirm that the change will not lead to problems. The characteristics of a microprocessing unit or microcontroller unit products in the same group but having a different part number might differ in terms of internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.

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(Rev.4.0-1 November 2017)

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